SFH 7252

Multi TOPLED®

Infrared Emitter (850 nm) and
Infrared Emitter (940 nm)

Applications

- Medical Illumination

Features:

- Package: SMT package, clear epoxy
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)
- SMT package with two IR emitter (850 nm & 940 nm)
- Suitable for SMT assembly
- Available on tape and reel
- Emitters can be controlled separately

Ordering Information

Type	Brightness [1)2)]	Ordering Code
SFH 7252		Q65111A9398
• infrared (850 nm)	• I_e = ≥ 7.1 mW/sr (I_F = 70 mA)	
• infrared (940 nm)	• I_e = ≥ 7.1 mW/sr (I_F = 70 mA)	

Maximum Ratings

T_A = 25 °C

Parameter	Symbol		Values ● infrared (850 nm)	Values ● infrared (940 nm)
Operating temperature	T_{op}	min. max.	-40 °C 100 °C	-40 °C 100 °C
Storage temperature	T_{stg}	min. max.	-40 °C 100 °C	-40 °C 100 °C
Forward current	I_F	max.	70 mA	70 mA
Surge current $t_p \leq 200$ µs; D = 0	I_{FSM}	max.	1 A	1 A
Reverse voltage [3)]	V_R	max.	5 V	5 V
Power consumption	P_{tot}	max.	140 mW	135 mW
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}	max.	2 kV	2 kV

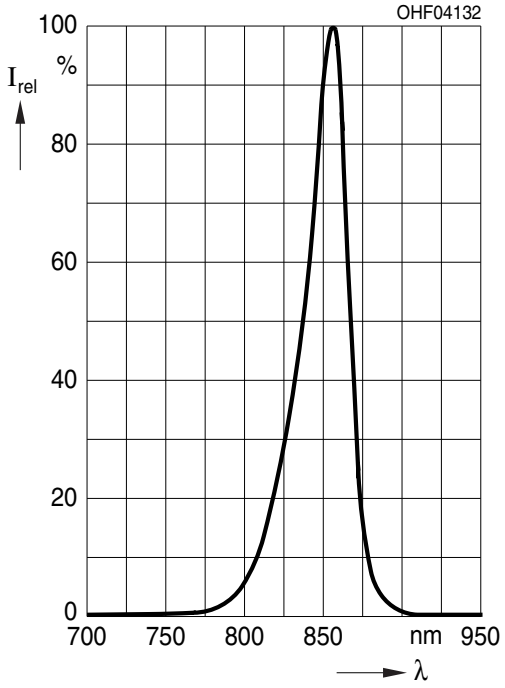
Characteristics

I_F = 70 mA; t_p = 20 ms; T_A = 25 °C

Parameter	Symbol		Values ● infrared (850 nm)	Values ● infrared (940 nm)
Peak wavelength	λ_{peak}	typ.	860 nm	950 nm
Centroid wavelength	$\lambda_{centroid}$	typ.	850 nm	940 nm
Spectral bandwidth at 50% $I_{rel,max}$ (FWHM)	$\Delta\lambda$	typ.	30 nm	42 nm
Half angle	φ	typ.	60 °	60 °
Dimensions of active chip area	L x W	typ.	0.3 x 0.3 mm x mm	0.3 x 0.3 mm x mm
Rise time (10% / 90%) I_F = 70 mA; R_L = 50 Ω	t_r	typ.	12 ns	12 ns
Fall time (10% / 90%) I_F = 70 mA; R_L = 50 Ω	t_f	typ.	12 ns	12 ns
Forward voltage [4]	V_F	typ. max.	1.6 V 1.9 V	1.50 V 1.80 V
Forward voltage [4] I_F = 1 A; t_p = 100 µs	V_F	typ. max.	3.6 V 4.5 V	3.6 V 4.5 V
Reverse current [3] V_R = 5 V	I_R	max.	10 µA	10 µA
Radiant intensity [1][2]	I_e	min. typ.	7.1 mW/sr 15 mW/sr	7.1 mW/sr 15 mW/sr
Total radiant flux [5]	Φ_e	typ.	50 mW	50 mW
Temperature coefficient of voltage	TC_V	typ.	-0.6 mV / K	-0.8 mV / K
Temperature coefficient of brightness	TC_I	typ.	-0.3 % / K	-0.3 % / K
Temperature coefficient of wavelength	TC_λ	typ.	0.3 nm / K	0.3 nm / K
Thermal resistance junction ambient real	R_{thJA}	max.	500 K / W	500 K / W

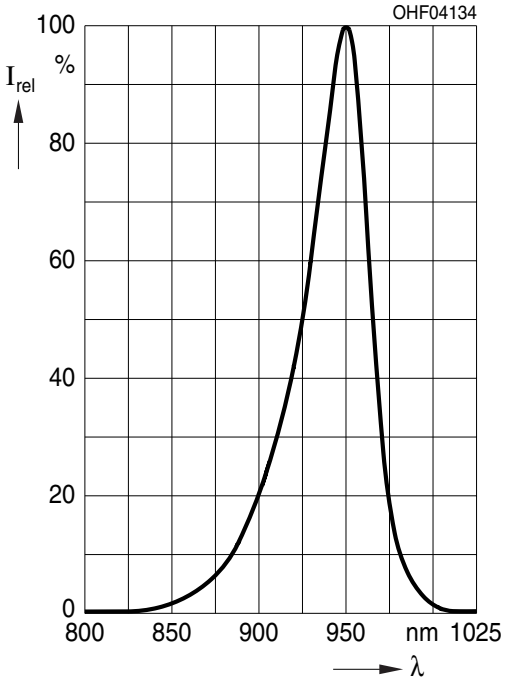
Relative Spectral Emission [6]

- infrared (850 nm): $I_{e,rel} = f(\lambda)$



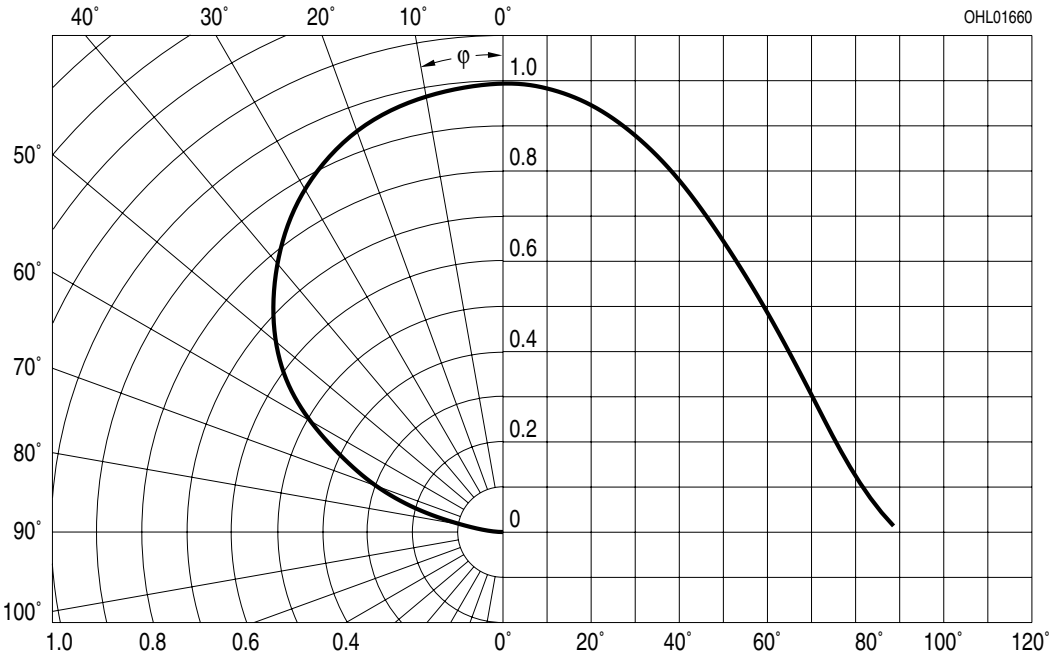
Relative Spectral Emission [6]

- infrared (940 nm): $I_{e,rel} = f(\lambda)$



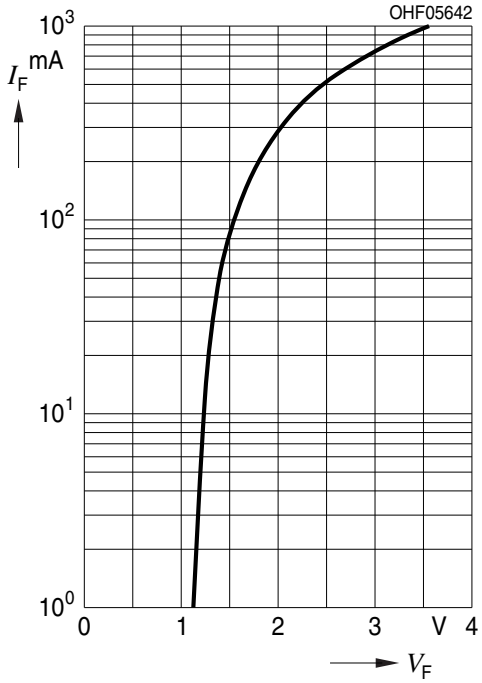
Radiation Characteristics [6]

$I_{e,rel} = f(\varphi)$



Forward current [6), 7)]

- infrared (940 nm): $I_F = f(V_F)$; single pulse; $t_p = 100\ \mu s$



Forward current [6), 7)]

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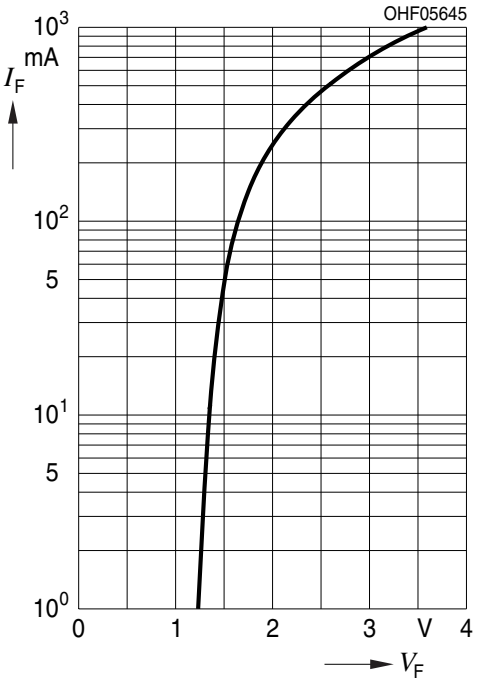

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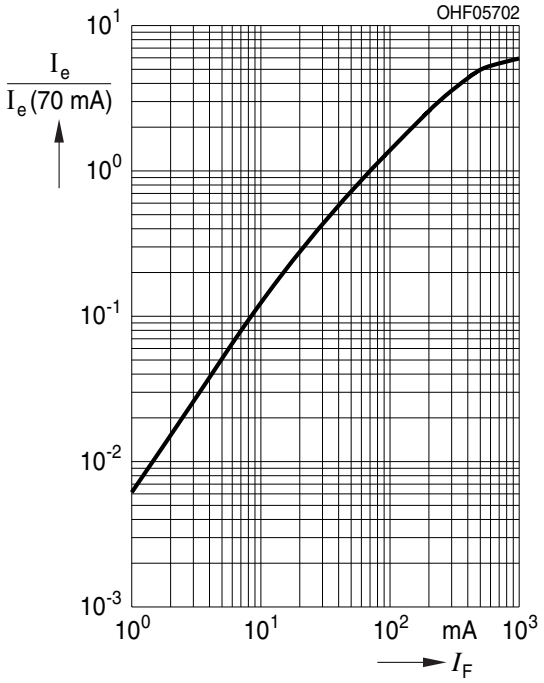
Relative Radiant Intensity [6), 7)]

$I_e/I_{e(70mA)} = f(I_F)$; single pulse; $t_p = 25\ \mu s$

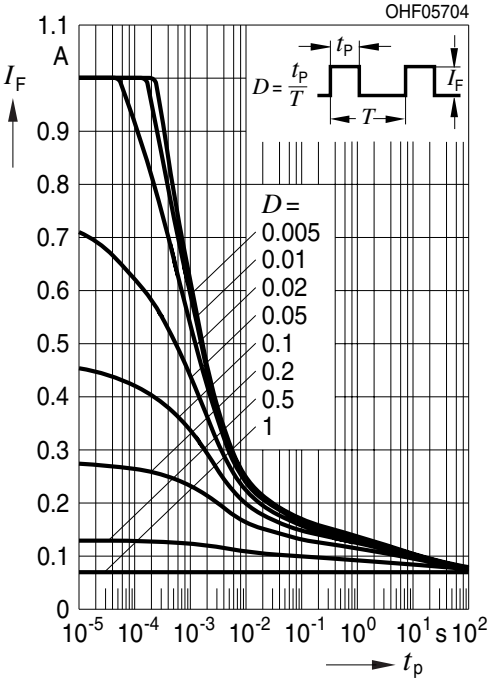


Max. Permissible Forward Current

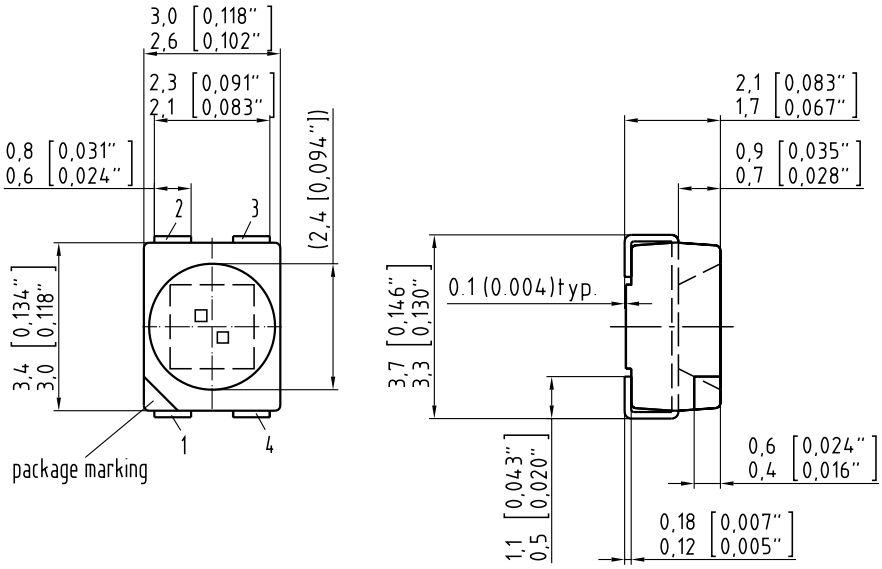
$I_{F,max} = f(T_A)$; $Rth_{ja} = 500K / W$

Permissible Pulse Handling Capability

$I_F = f(t_p)$; D = parameter; $T_A = 25\ °C$



Dimensional Drawing [8)]



C63062-A4175-A1-02

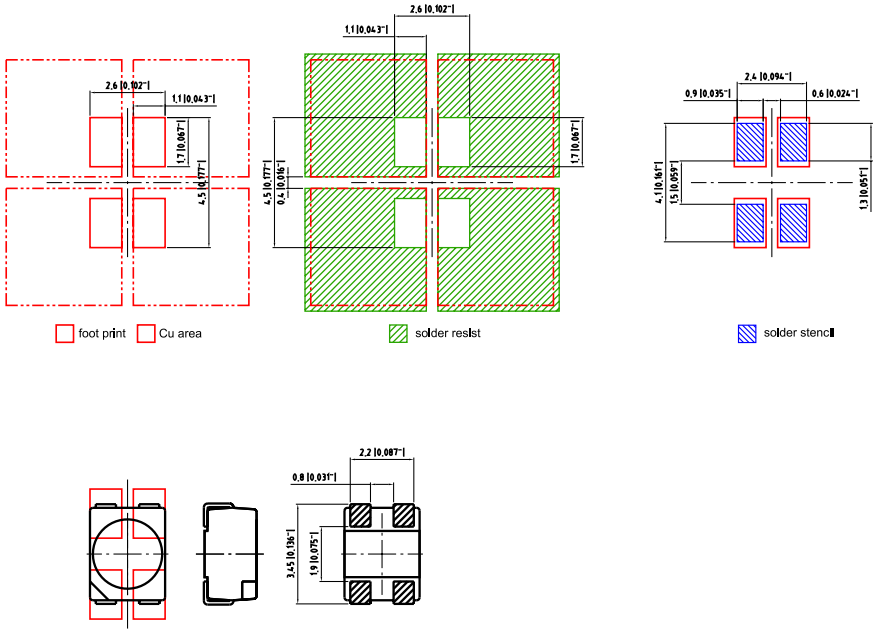
Further Information:

Approximate Weight: 34.0 mg

Package marking: Cathode

Pin	Description
1	Cathode Emitter 2 (940 nm)
2	Anode Emitter 2 (940 nm)
3	Cathode Emitter 1 (850 nm)
4	Anode Emitter 1 (850nm)

Recommended Solder Pad [8)]



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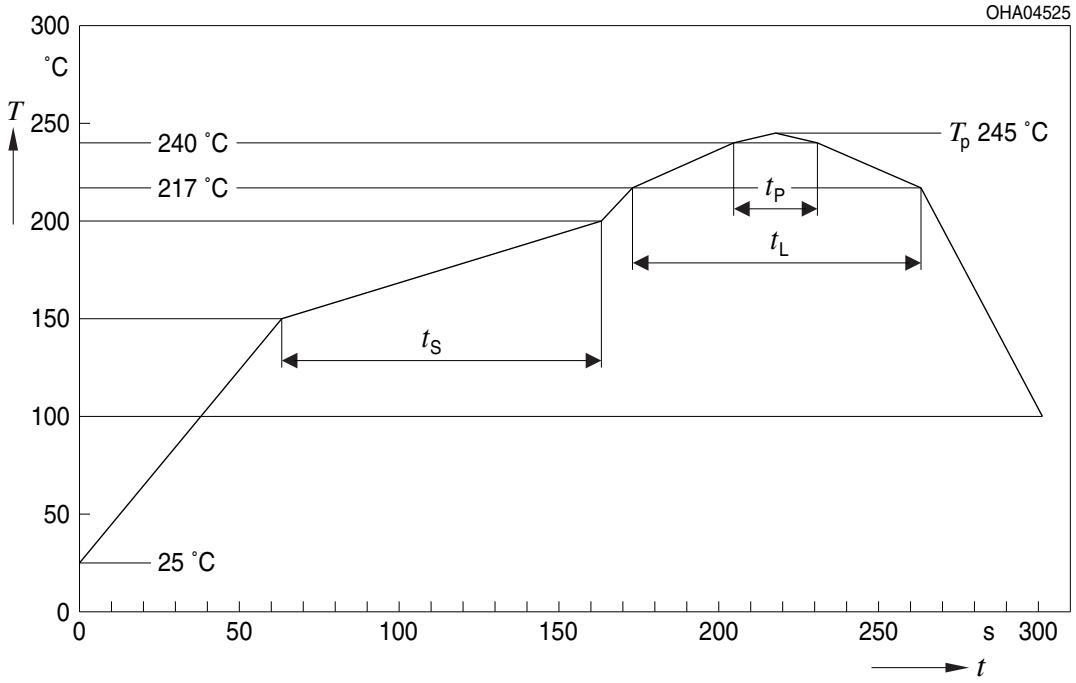
Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_S T_{Smin} to T_{Smax}	t_S	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_P			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_P		245	260	°C
Time within 5 °C of the specified peak temperature T_P - 5 K	t_P	10	20	30	s
Ramp-down rate* T_P to 100 °C			3	6	K/s
Time 25 °C to T_P				480	s

All temperatures refer to the center of the package, measured on the top of the component
* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

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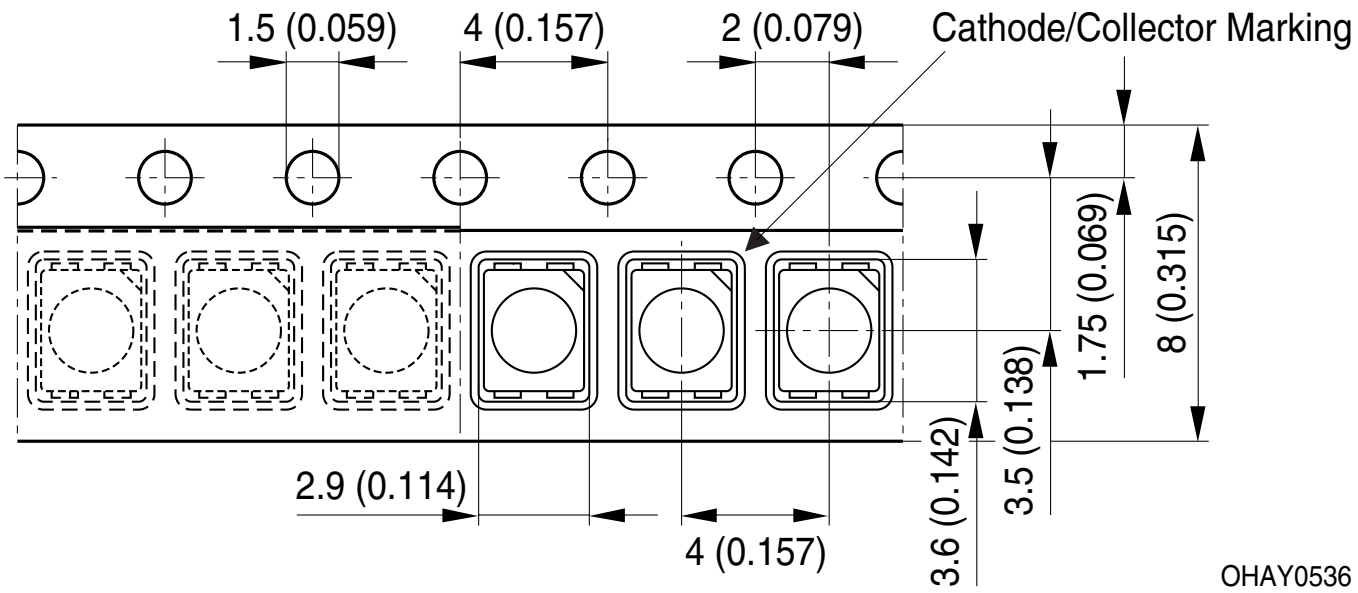
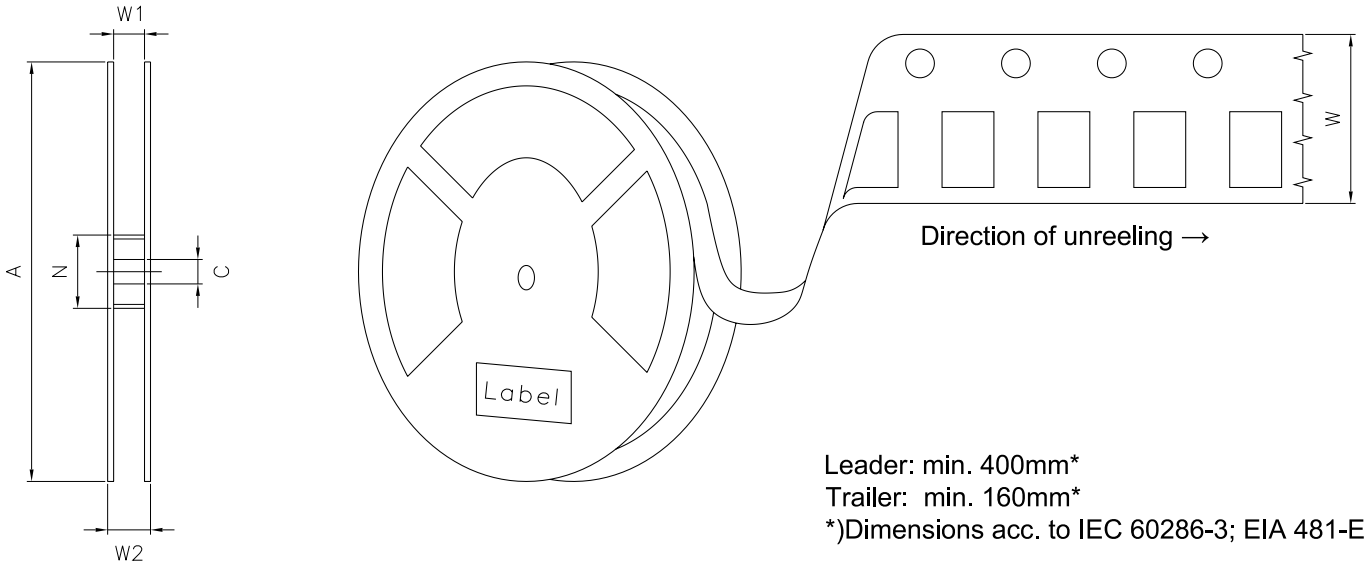
Taping [8)]


1.5 (0.059)
4 (0.157)
2 (0.079)
Cathode/Collector Marking
1.75 (0.069)
8 (0.315)
3.5 (0.138)
3.6 (0.142)
2.9 (0.114)
4 (0.157)
OHAY0536

Tape and Reel [9)]

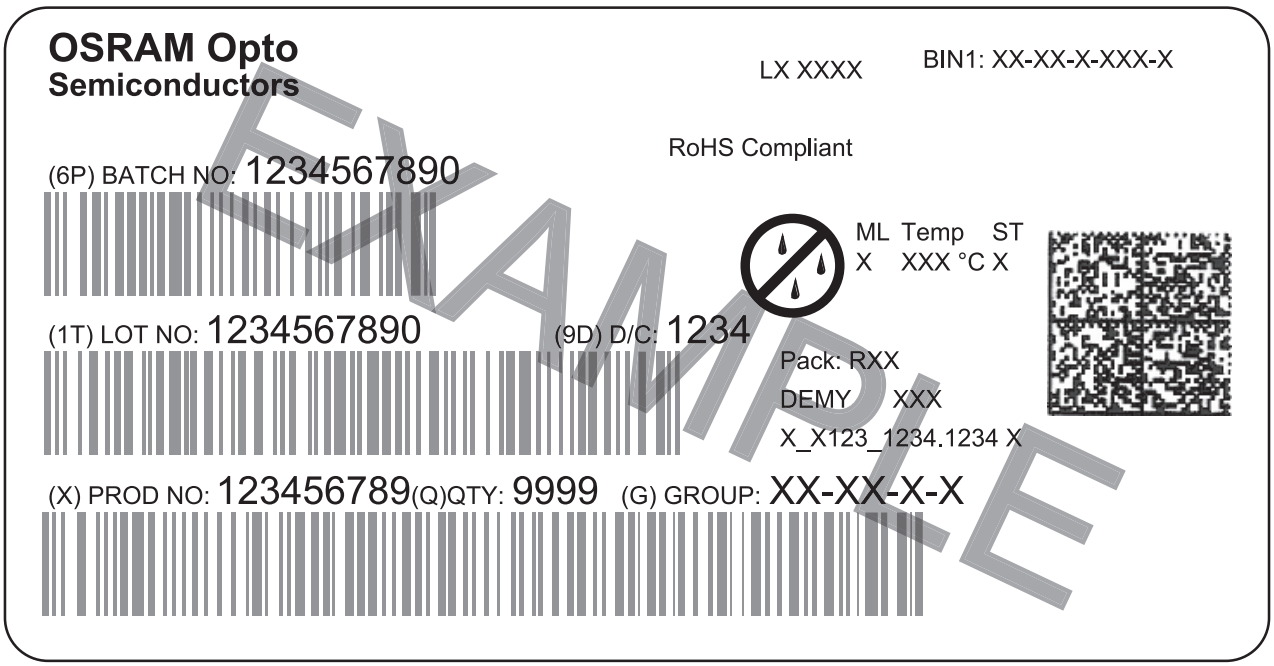


Leader: min. 400mm*
Trailer: min. 160mm*
*)Dimensions acc. to IEC 60286-3; EIA 481-E

Reel Dimensions

A	W	N_{min}	W_1	$W_{2\,max}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	2000
330 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	8000

Barcode-Product-Label (BPL)



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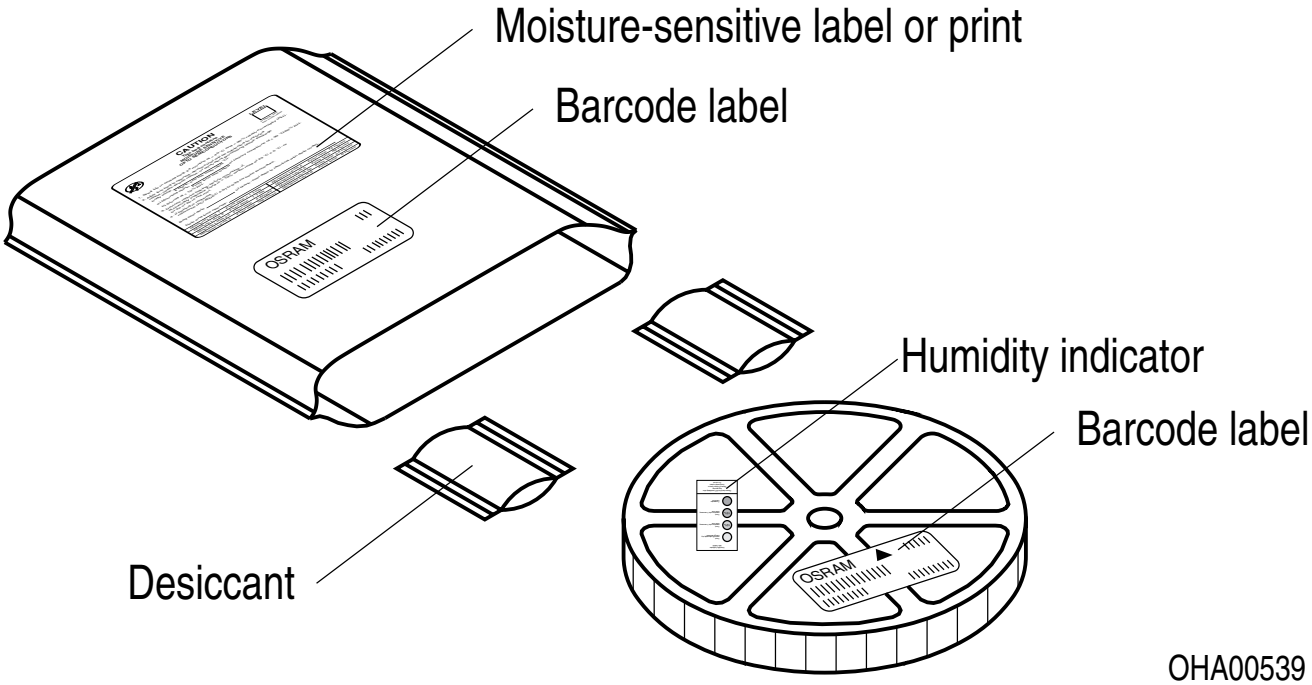
Dry Packing Process and Materials [8)]



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Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!
The information describes the type of component and shall not be considered as assured characteristics.
Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.
For information on the types in question please contact our Sales Organization.
If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing
Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications
OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.
OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

Glossary

1) **Radiant intensity:** Measured at a solid angle of Ω = 0.01 sr

2) **Brightness:** The brightness values are measured with a tolerance of ±11%.

3) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.

4) **Forward Voltage:** The forward voltages are measured with a tolerance of ±0.1 V.

5) **Total radiant flux:** Measured with integrating sphere.

6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

7) **Testing temperature:** TA = 25°C (unless otherwise specified)

8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.

9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.1	2020-12-17	Schematic Transportation Box Dimensions of Transportation Box

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